



The DNA of tech.™

Change of the die in TEMD5080X01 from 4" to 6" wafer

For further information, please contact your regional Vishay office.

CONTACT INFORMATION

Americas

Jim Toal
2585 Junction Avenue
-
San Jose California United States 95134-1923
Phone: +1.408.348.0749
Fax:
jim.toal@vishay.com

Europe

Boris Lazic
Theresienstr. 2
-
Heilbronn Germany 74025
Phone: +49-151 4256 9007
Fax:
boris.lazic@vishay.com

Asia

Jason Soon
37A Tampines Street 92 # 07-01
-
Singapore Singapore 528886
Phone: (65) 8778 5656
Fax:
jason.soon@vishay.com

Description of Change: Change of the die from 4 inch to 6 inch

Reason for Change: Change of the die from 4 inch to 6 inch

Expected Influence on Quality/Reliability/Performance: no influence on quality, reliability and performance, however we request customer to test product in customer application

Part Numbers/Series/Families Affected: TEMD5080X01

Vishay Brand(S): Vishay Semiconductors

Time Schedule:

Start Shipment Date: Friday January 1, 2027

Sample Availability: available upon request

Product Identification: label

Qualification Data: available upon request

This PCN is considered approved, without further notification, unless we receive specific customer concerns before Friday May 15, 2026 or as specified by contract.

Issued By: Elena Foddi, elena.foddi@vishay.com